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Fairchild Semiconductor FQP13N06L

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November 2013

FQP13N06L

N-Channel QFET[®] MOSFET 60 V, 13.6 A, 110 m Ω

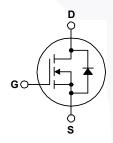
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 13.6 A, 60 V, $R_{DS(on)}$ = 110 m Ω (Max.) @ V_{GS} = 10 V, I_D = 6.8 A
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 17 pF)
- · 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP13N06L	Unit
V_{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°C)		13.6	Α
	- Continuous (T _C = 100°C)		9.6	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	54.4	Α
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	90	mJ
I _{AR}	Avalanche Current	(Note 1)	13.6	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		45	W
	- Derate above 25°C		0.3	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQP13N06L	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	3.35	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	



Datasheet of FQP13N06L - MOSFET N-CH 60V 13.6A TO-220 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP13N06L	FQP13N06L	TO-220	Tube	N/A	N/A	50 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.05		V/°C
I _{DSS}	7 0 1 1/1 5 1 0 1	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 48 V, T _C = 150°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward V _{GS} = 20 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics	,				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 6.8 A		0.088	0.11	0
()	On-Resistance			0.110	0.14	Ω
9 _{FS}	Forward Transconductance	Forward Transconductance $V_{DS} = 25 \text{ V}, I_D = 6.8 \text{ A}$		7		S
	ic Characteristics			070	050	
Ciss	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		270	350	pF
Coss	Output Capacitance			95	125	pF
C _{rss}	Reverse Transfer Capacitance			17	23	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 6.8 A,		8	25	ns
t _r	Turn-On Rise Time	$R_{G} = 25 \Omega$		90	190	ns
t _{d(off)}	Turn-Off Delay Time			20	50	ns
t _f	Turn-Off Fall Time	(Note 4)	/	40	90	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 13.6 A,		4.8	6.4	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		1.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		2.7	/	nC
_				•	У	
	Source Diode Characteristics an				40.0	
l _S	Maximum Continuous Drain-Source Diode Forward Current				13.6	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				54.4	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 13.6 A			1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 13.6 \text{ A},$		45		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		45		nC

Q_{rr}

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature. 2. L = 570 μ H, I_{AS} = 13.6 A, V_{DD} = 25 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. I_{SD} \leq 13.6 A, di/dt \leq 300 A/ μ s, V_{DD} \leq BV $_{DSS}$, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.



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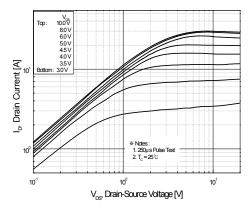


Figure 1. On-Region Characteristics

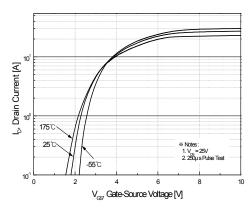


Figure 2. Transfer Characteristics

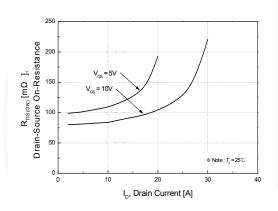


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

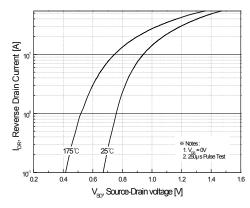


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

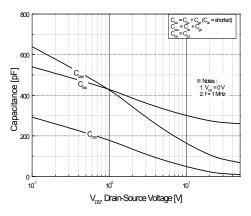


Figure 5. Capacitance Characteristics

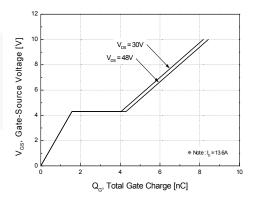
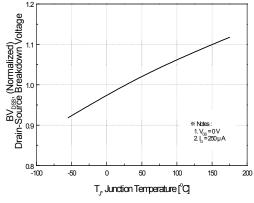


Figure 6. Gate Charge Characteristics



Typical Characteristics (continued)



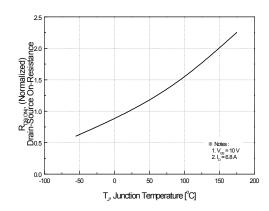
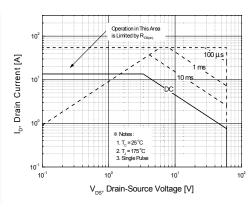


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



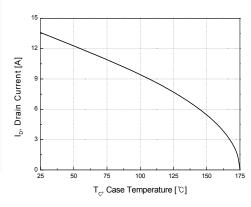


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

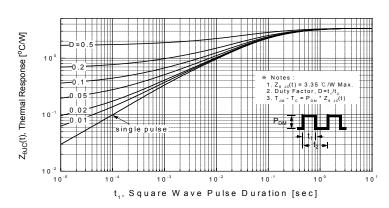
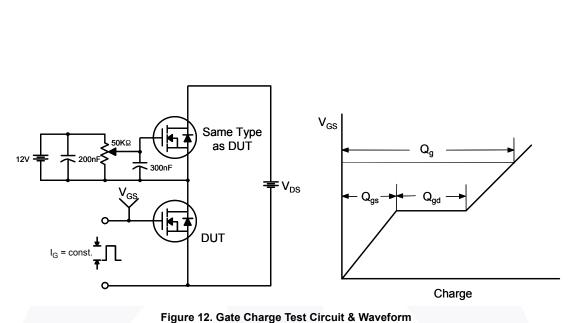


Figure 11. Transient Thermal Response Curve





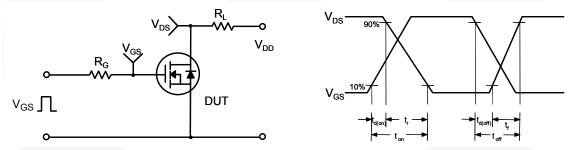


Figure 13. Resistive Switching Test Circuit & Waveforms

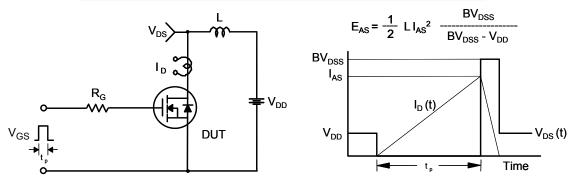
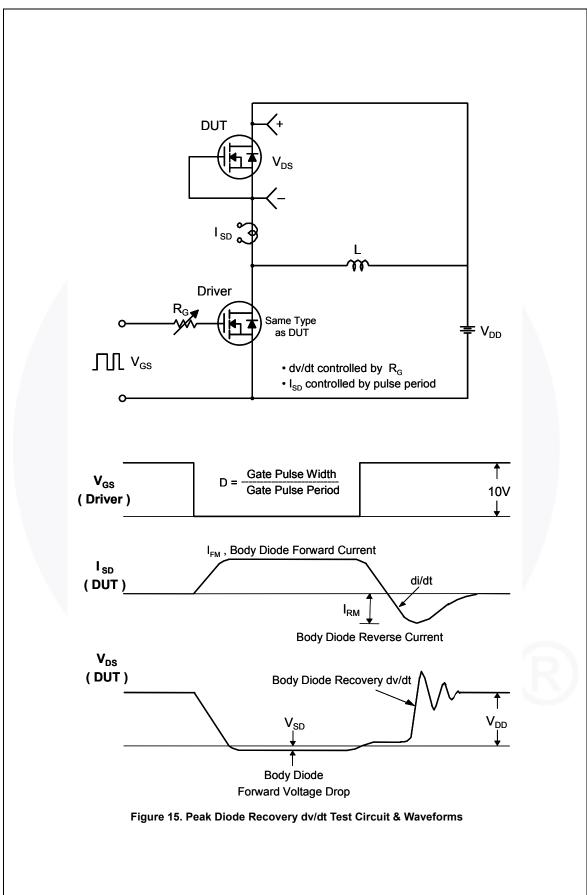


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Mechanical Dimensions

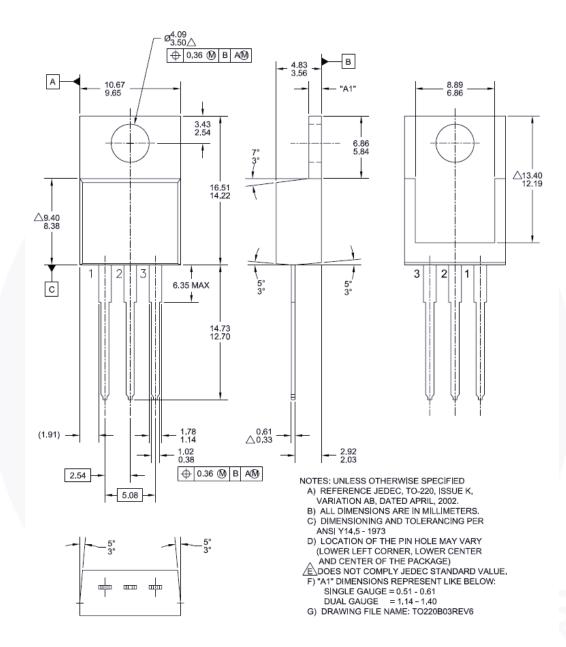


Figure 16 TO-220, Molded, 3-Lead, Jedec Variation AB

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